74LVC16244A-Q100; 74LVCH16244A-Q100

16-bit buffer/line driver; 5 V input/output tolerant; 3-state

Rev. 2 — 27 September 2013

Product data sheet

1. General description

The 74LVC16244A-Q100; 74LVCH16244A-Q100 are 16-bit non-inverting buffer/line drivers with 3-state bus compatible outputs. The device can be used as four 4-bit buffers, two 8-bit buffers or one 16-bit buffer. It features four output enable inputs ($1\overline{OE}$ to $4\overline{OE}$) each controlling four of the 3-state outputs. A HIGH on nOE causes the outputs to assume a high-impedance OFF-state.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices in mixed 3.3 V and 5 V applications.

The 74LVCH16244A-Q100 bus hold on data inputs eliminates the need for external pull-up resistors to hold unused inputs.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Multibyte flow-through standard pinout architecture
- Low inductance multiple power and ground pins for minimum noise and ground bounce
- Direct interface with TTL levels
- High-impedance when V_{CC} = 0 V
- All data inputs have bus hold. (74LVCH16244A-Q100 only)
- Complies with JEDEC standard:
 - ◆ JESD8-7A (1.65 V to 1.95 V)
 - JESD8-5A (2.3 V to 2.7 V)
 - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)



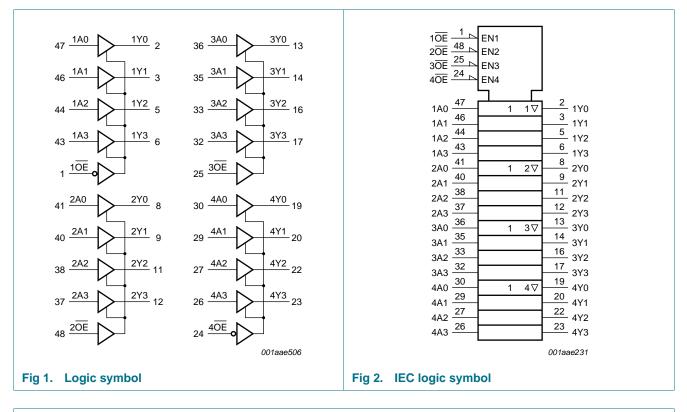
16-bit buffer/line driver; 5 V input/output tolerant; 3-state

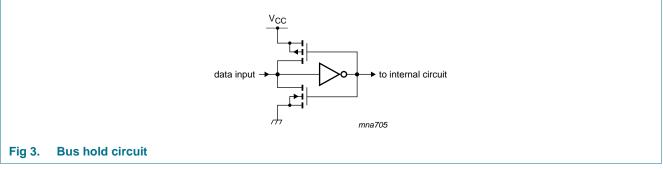
3. Ordering information

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Table 1. Ordering information									
Type number									
		Name	Description	Version					
74LVC16244ADGG-Q100	–40 °C to +125 °C	TSSOP48	plastic thin shrink small outline package;	SOT362-1					
74LVCH16244ADGG-Q100			48 leads; body width 6.1 mm						

4. Functional diagram



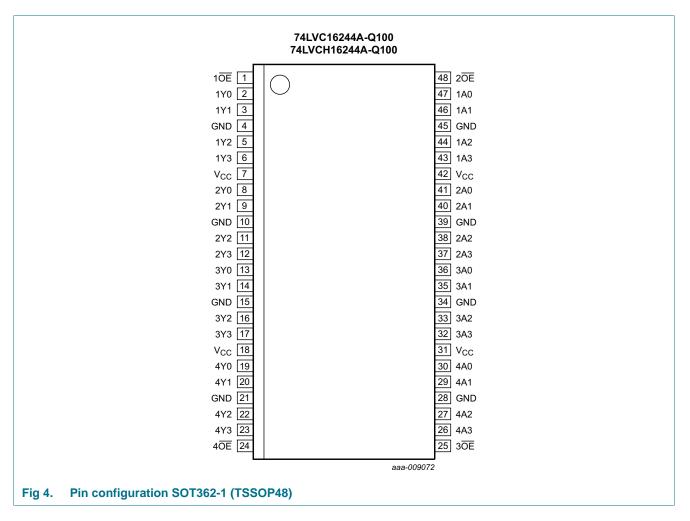


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5. Pinning information

5.1 Pinning



16-bit buffer/line driver; 5 V input/output tolerant; 3-state

5.2 Pin description

Table 2. Pin descr	iption	
Symbol	Pin	Description
$1\overline{OE}$, $2\overline{OE}$, $3\overline{OE}$, $4\overline{OE}$	1, 48, 25, 24	output enable input (active LOW)
1Y0 to 1Y3	2, 3, 5, 6	data output
2Y0 to 2Y3	8, 9, 11, 12	data output
3Y0 to 3Y3	13, 14, 16, 17	data output
4Y0 to 4Y3	19, 20, 22, 23	data output
GND	4, 10, 15, 21, 28, 34, 39, 45	ground (0 V)
V _{CC}	7, 18, 31, 42	supply voltage
1A0 to 1A3	47, 46, 44, 43	data input
2A0 to 2A3	41, 40, 38, 37	data input
3A0 to 3A3	36, 35, 33, 32	data input
4A0 to 4A3	30, 29, 27, 26	data input
n.c.	-	not connected

6. Functional description

Table 3. Function table^[1]

Control	Input	Output
nOE	nAn	nYn
L	L	L
L	Н	Н
Н	Х	Z

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

16-bit buffer/line driver; 5 V input/output tolerant; 3-state

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V ₁ < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
I _{OK}	output clamping current	$V_{O} > V_{CC}$ or $V_{O} < 0 V$	-	±50	mA
Vo	output voltage	output HIGH or LOW	<u>[2]</u> –0.5	V _{CC} + 0.5	V
		output 3-state	<u>[2]</u> –0.5	+6.5	V
lo	output current	$V_{O} = 0 V$ to V_{CC}	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C$ to +125 $^{\circ}C$;	[3] _	500	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] Above 60 °C, the value of P_{tot} derates linearly with 5.5 mW/K.

8. Recommended operating conditions

Table 5. Recommended operating conditions

	1 0					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		2.7	-	3.6	V
		functional	1.2	-	3.6	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW	0	-	V _{CC}	V
		output 3-state	0	-	5.5	V
T _{amb}	ambient temperature	in free air	-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V_{CC} = 1.2 V to 2.7 V	0	-	20	ns/V
		V_{CC} = 2.7 V to 3.6 V	0	-	10	ns/V

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9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	35 °C	–40 °C to +125 °C		
			Min	Typ[1]	Max	Min	Max	
VIH	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	V_{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0	-	-	2.0	-	V
V _{IL}	LOW-level	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V_{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	0.8	-	0.8	V
V _{OH}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8$ mA; $V_{CC} = 2.3$ V	1.8	-	-	1.65	-	V
		$I_0 = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
	$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V	
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
√ _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = 100 \ \mu\text{A};$ $V_{CC} = 1.65 \ \text{V} \text{ to } 3.6 \ \text{V}$	-	-	0.2	-	0.3	V
		$I_0 = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_0 = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		I_{O} = 12 mA; V_{CC} = 2.7 V	-	-	0.4	-	0.6	V
		$I_{O} = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
1	input leakage current	V _{CC} = 3.6 V; V _I = 5.5 V or GND	-	±0.1	±5	-	±20	μA
ΟZ	OFF-state output current	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 3.6 \text{ V};$ [2] $V_{O} = 5.5 \text{ V or GND};$	-	±0.1	±5	-	±20	μA
OFF	power-off leakage current	V_{CC} = 0 V; V _I or V _O = 5.5 V	-	±0.1	±10	-	±20	μA
СС	supply current	$V_{CC} = 3.6 \text{ V};$ $V_I = V_{CC} \text{ or GND}; I_O = 0 \text{ A}$	-	0.1	20	-	80	μA
VI _{CC}	additional supply current	per input pin; $V_{CC} = 2.7 V \text{ to } 3.6 V;$ $V_I = V_{CC} - 0.6 V; I_O = 0 A$	-	5	500	-	5000	μA
CI	input capacitance	$V_{CC} = 0 V \text{ to } 3.6 V;$ $V_I = GND \text{ to } V_{CC}$	-	5.0	-	-	-	pF

16-bit buffer/line driver; 5 V input/output tolerant; 3-state

Symbol	Parameter	Conditions		-40) °C to +85	5 °C	-40 °C to	o +125 ℃	Unit
			-	Min	Typ <mark>[1]</mark>	Max	Min	Max	_
I _{BHL}	bus hold	V_{CC} = 1.65; V_{I} = 0.58 V	[3][4]	10	-	-	10	-	μA
	LOW current	$V_{CC} = 2.3; V_I = 0.7 V$		30	-	-	25	-	μA
		$V_{CC} = 3.0; V_I = 0.8 V$		75	-	-	60	-	μA
I _{BHH}	I _{BHH} bus hold HIGH current	V_{CC} = 1.65; V_{I} = 1.07 V	[3][4]	-10	-	-	-10	-	μA
		$V_{CC} = 2.3; V_I = 1.7 V$		-30	-	-	-25	-	μA
		$V_{CC} = 3.0; V_{I} = 2.0 V$		-75	-	-	-60	-	μA
I _{BHLO}	bus hold	V _{CC} = 1.95 V	[3][5]	200	-	-	200	-	μA
	LOW overdrive	$V_{CC} = 2.7 V$		300	-	-	300	-	μA
	current	V _{CC} = 3.6 V		500	-	-	500	-	μΑ
I _{BHHO}	bus hold	V _{CC} = 1.95 V	[3][5]	-200	-	-	-200	-	μA
	HIGH overdrive current	V _{CC} = 2.7 V		-300	-	-	-300	-	μA
		V _{CC} = 3.6 V		-500	-	-	-500	-	μA

Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.

[2] The bus hold circuit is switched off when $V_I > V_{CC}$ allowing 5.5 V on the input terminal.

[3] Valid for data inputs only. Control inputs do not have a bus hold circuit.

[4] The specified sustaining current at the data input holds the input below the specified V₁ level.

[5] The specified overdrive current at the data input forces the data input to the opposite logic input state.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit, see Figure 7.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	–40 °C to	o +125 °C	Unit
				Min	Typ ^[2]	Max	Min	Мах	
t _{pd}	propagation	nAn to nYn; see Figure 5	<u>[1]</u>						
	delay	V _{CC} = 1.2 V		-	11.0	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		1.5	4.8	10.7	1.5	11.3	ns
		V_{CC} = 2.3 V to 2.7 V		1.0	2.6	5.3	1.0	5.9	ns
		$V_{CC} = 2.7 V$		1.0	2.6	4.7	1.0	6.0	ns
		V_{CC} = 3.0 V to 3.6 V		1.1	2.2	4.1	1.1	5.5	ns
t _{en}	enable time	nOE to nYn; see <u>Figure 6</u>	<u>[1]</u>						
		V _{CC} = 1.2 V		-	15.0	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		1.5	6.2	12.1	1.5	12.7	ns
		V_{CC} = 2.3 V to 2.7 V		1.0	3.5	6.4	1.0	7.1	ns
		$V_{CC} = 2.7 V$		1.0	3.3	5.8	1.0	7.5	ns
		V_{CC} = 3.0 V to 3.6 V		1.0	2.8	4.6	1.0	6.0	ns

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Symbol	Parameter	rameter Conditions		–40 °C to +85 °C			–40 °C to +125 °C		Unit
				Min	Typ ^[2]	Max	Min	Max	
t _{dis}	disable time	nOE to nYn; see Figure 6	<u>[1]</u>					·	
		$V_{CC} = 1.2 V$		-	10.0	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		2.5	4.4	8.7	2.5	9.4	ns
		V_{CC} = 2.3 V to 2.7 V		1.0	2.4	4.9	1.0	5.3	ns
		$V_{CC} = 2.7 V$		1.0	3.2	6.2	1.0	8.0	ns
		V_{CC} = 3.0 V to 3.6 V		1.8	3.1	5.2	1.8	6.5	ns
C _{PD}	power	per input; $V_I = GND$ to V_{CC}	<u>[3]</u>						
	dissipation capacitance	V_{CC} = 1.65 V to 1.95 V		-	4.8	-	-	-	pF
	capacitance	V_{CC} = 2.3 V to 2.7 V		-	8.3	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	11.4	-	-	-	pF

Table 7. Dynamic characteristics ... continued

Voltages are referenced to GND (ground = 0 V). For test circuit, see Figure 7.

t_{pd} is the same as t_{PLH} and t_{PHL}.
 t_{en} is the same as t_{PZL} and t_{PZH}.
 t_{dis} is the same as t_{PLZ} and t_{PHZ}.

[2] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz; f_o = output frequency in MHz

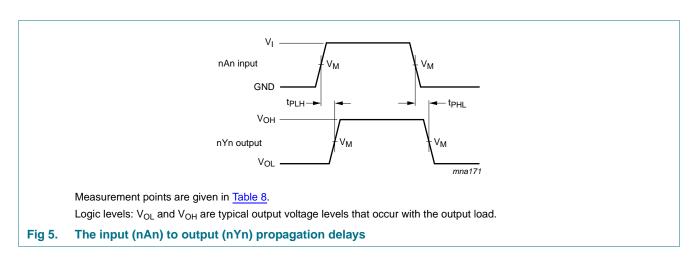
 C_L = output load capacitance in pF

V_{CC} = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

11. Waveforms



ors 74LVC16244A-Q100; 74LVCH16244A-Q100

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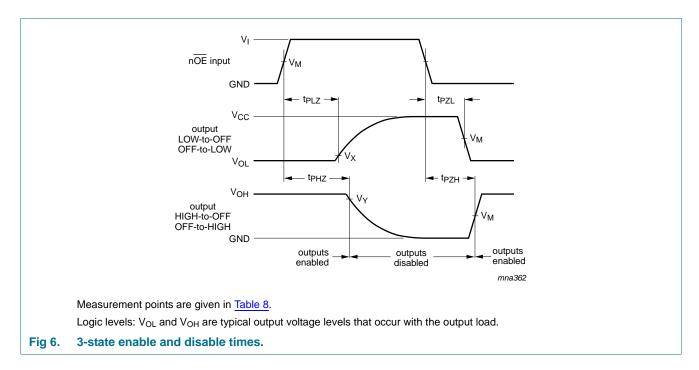


Table 8. Measurement points

		-						
Supply voltage	V _M	Input	Input					
V _{CC}		VI	$t_r = t_f$	V _X	V _Y			
1.2 V	$0.5\times V_{CC}$	V _{CC}	\leq 2.5 ns	V _{OL} + 0.15 V	$V_{OH} - 0.15 \ V$			
1.65 V to 1.95 V	$0.5\times V_{CC}$	V _{CC}	\leq 2.5 ns	V _{OL} + 0.15 V	V _{OH} – 0.15 V			
2.3 V to 2.7 V	$0.5\times V_{CC}$	V _{CC}	\leq 2.5 ns	V _{OL} + 0.15 V	V _{OH} – 0.15 V			
2.7 V	1.5 V	2.7 V	\leq 2.5 ns	V _{OL} + 0.3 V	V _{OH} – 0.3 V			
3.0 V to 3.6 V	1.5 V	2.7 V	\leq 2.5 ns	V _{OL} + 0.3 V	V _{OH} – 0.3 V			

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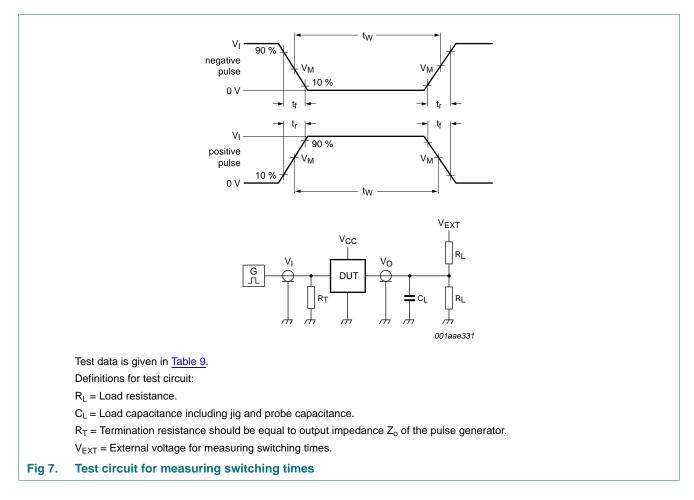


Table 9	. Test	data
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Supply voltage	Input		Load	Load					
	VI	t _r , t _f	CL	RL	t _{PLH} , t _{PHL}	t _{PLZ} , t _{PZL}	t _{PHZ} , t _{PZH}		
1.2 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND		
1.65 V to 1.95 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND		
2.3 V to 2.7 V	V _{CC}	\leq 2 ns	30 pF	500 Ω	open	$2 \times V_{CC}$	GND		
2.7 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND		
3.0 V to 3.6 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND		

16-bit buffer/line driver; 5 V input/output tolerant; 3-state

12. Package outline

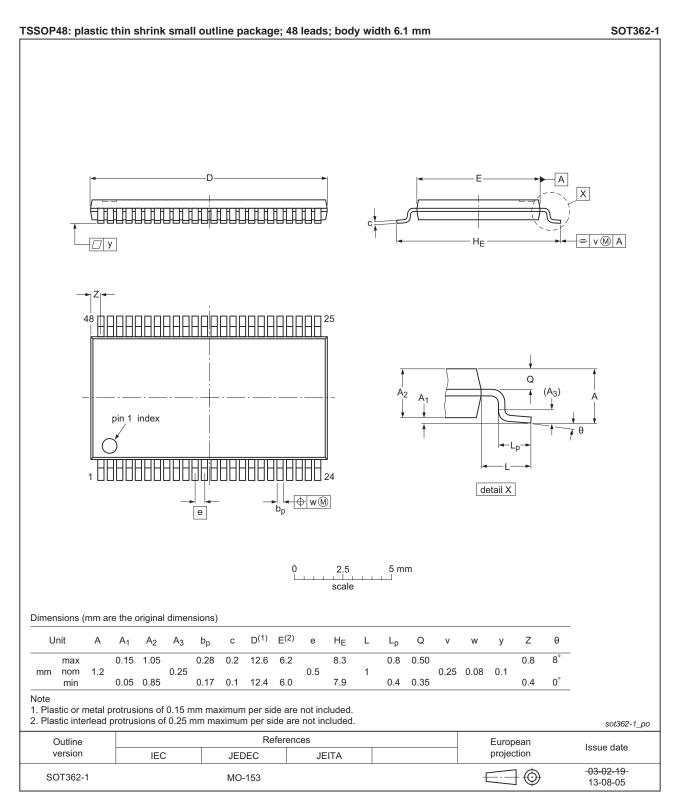


Fig 8. Package outline SOT362-1 (TSSOP48)

16-bit buffer/line driver; 5 V input/output tolerant; 3-state

13. Abbreviations

Table 10.	Table 10. Abbreviations			
Acronym	Description			
CDM	Charged Device Model			
CMOS	Complementary Metal Oxide Semiconductor			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
HBM	Human Body Model			
MIL	Military			
MM	Machine Model			
TTL	Transistor-Transistor Logic			

14. Revision history

Table 11. Revision history							
Release date	Data sheet status	Change notice	Supersedes				
20130927	-	-	74LVC_LVCH16244A_Q100 v.1				
Modifications: • Typo removed from the title header.							
20130923	Product data sheet	-	-				
	20130927 • Typo remo	20130927 - • Typo removed from the title heat	20130927 - - • Typo removed from the title header.				

16-bit buffer/line driver; 5 V input/output tolerant; 3-state

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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